

06-21-2004



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Samanatha J. Edirisooriya June 3, 2004
Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies):
Intel Corporation
2200 Mission College Blvd., Santa Clara, CA 95052

3. Nature of conveyance:
☒ Assignment ☐ Merger
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4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: June 3, 2004

A. Patent Application No.(s):

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5. Name and address of party to whom correspondence concerning document should be mailed:

Janaki K. Davda
KONRAD RAYNES & VICTOR, LLP
315 S. Beverly Drive, Suite 210
Beverly Hills, CA 90212

6. Total number of applications and patents involved: [1]

7. Total fee (37 CFR 3.41).....\$ 40

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06/18/2004 NGETACHE 00000071 10866406

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PATENT
REEL: 015463 FRAME: 0786

ASSIGNMENT

Whereas, we

INVENTOR
AND CITY

(1) Samanatha J. Edirisooriya
County of Maricopa

of Tempe
and State of Arizona

have invented certain improvement in

TITLE MAPPING DATA BLOCKS TO STORAGE BLOCKS

DATES THAT
INVENTORS
SIGNED THE
DECLARATION

and executed, respectively, a United States patent application therefore on
(1) 06/03/, 2004


Whereas, INTEL CORPORATION, a corporation of Delaware, having a place of business at 2200 Mission College Blvd., Santa Clara, CA 95052, (hereinafter called INTEL CORPORATION), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefore;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to INTEL CORPORATION, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to INTEL CORPORATION, its successors and assigns; and I hereby agree that INTEL CORPORATION may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by INTEL CORPORATION.

Signed and sealed

CITY
DATE

(1) at Chandler, AZ
on 06/03/, 2004,


Samanatha J. Edirisooriya

SIGNATURE
INVENTOR